First Edition Jun 4, 2002



LCD Module Technical Specification

Final Revision

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OPTREX CORPORATION

Type No	F-51553G	SNBJ-L	W-AB
			Approved by (Production Div.) Checked by (Quality Assurance Div.) Checked by (Design Engineering Div.)
			Prepared by (Production Div.) 4. Luracyans
	le of Contents		
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F-51553GNBJ-LW-AB (AB) No. 2002-S012

1. General Specifications

Operating Temp. : min. -20°C ~max. 70°C

Storage Temp. : min. -30°C ~max. 85°C

Dot Pixels : 128 (W) × 64 (H) dots

Dot Size : $0.48 \text{ (W)} \times 0.48 \text{ (H)} \text{ mm}$

Dot Pitch : $0.50 \text{ (W)} \times 0.50 \text{ (H)} \text{ mm}$

Viewing Area : $66.8 \text{ (W)} \times 35.5 \text{ (H)} \text{ mm}$

Outline Dimensions : $89.7 \text{ (W)} \times 49.8^* \text{ (H)} \times (11.8)^{**} \text{ (D)} \text{ mm}$

* Without FPCUV

** Without Fook of LED Backlight

Weight : 33.8g max.

LCD Type : NTD-21558 (STN / Blue-mode / Transmissive)

Viewing Angle : 6:00

Data Transfer // : 8-bit parallel data transfer

Backlight : LED Backlight / White

Drawings : Dimensional Outline UE-311234

2.Electrical Specifications

2.1. Absolute Maximum Ratings

GND=0V

Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	V _{DD} -GND	-	-0.3	7.0	V
(Logic)					
Supply Voltage	V _{DD} -GND	-	-6.0	+0.3	V
(Booster Circuit)					
Supply Voltage 1	V ₅ ,V _{OUT}	-	-18.0	+0.3	V
(LCD Drive)					
Input Voltage	Vin	-	-0.3	VDD+0.3	V

2.2.DC Characteristics

Ta=25°C, GND=0V

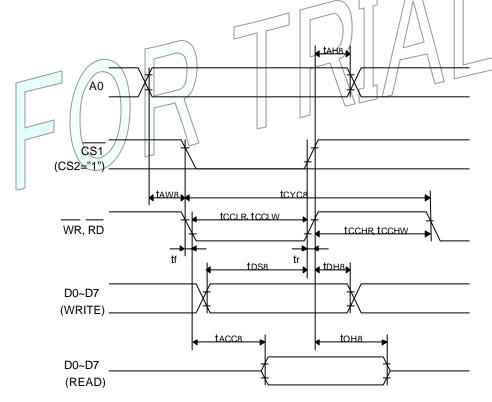
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage	V _{DD} -GND	With Triple	4.5	-	5.5	V
(Logic)						
Supply Voltage	Vdd-V5		Shown in 3.	1 / \		V
(LCD Drive)						
"High" Level	Vih	- 5	0.8×Vpp		VDD	V
Input Voltage						
"Low" Level	Mr/		GND		0.2× VDD	V
Input Voltage						
"High" Level	Vон	lон=-0.1mA	0.8 × VDD	-	Vdd	V
Output Voltage						
"Low" Level	Vol	loL=0.1mA	GND	-	0.2× Vdd	V
Output Voltage						
Supply Current	ldd	VDD-GND=5.0V	-	1.00	1.50	mA

2.3. AC Characteristics

2.3.1.Read/Write Operation Sequence (80 series CPU)

 $V_{DD}=5.0V\pm10\%$

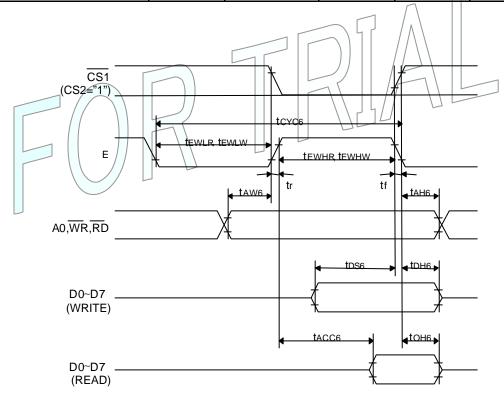
Parameter	Parameter		Min.	Max.	Units
Address Setup Time		t _{AW8}	0	-	ns
Address Hold Time		t _{AH8}	0	-	ns
System Cycle Time		t _{CYC8}	166	-	ns
Control Low Pulse Width	WRITE	t cclw	30	-	ns
	READ	t cclr	70	-	ns
Control High Pulse Width	WRITE	t cchw	30	-	ns
	READ	t cchr	30	-	ns
Data Setup Time		t _{DS8}	30	-	ns
Data Hold Time		t _{DH8}	10	-	ns
RD Access Time		t _{ACC8}	-	70	ns
Output Disable Time		t_{OH8}	5	50	ns



2.3.2.Read/Write Operation Sequence (68 series CPU)

 $V_{DD}=5.0V\pm10\%$

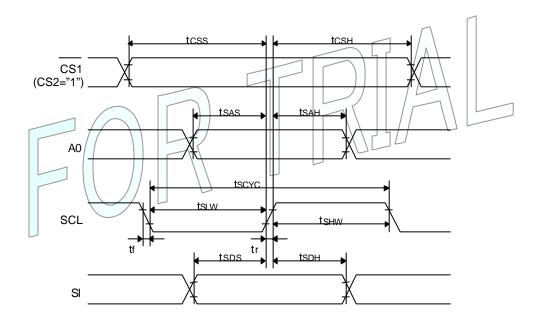
Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AH6}	0	-	ns
Address Hold Time		$t_{\sf AW6}$	0	-	ns
System Cycle Time		t _{CYC6}	166	-	ns
Data Setup Time		t _{DS6}	30	-	ns
Data Hold Time		\mathbf{t}_{DH6}	10	-	ns
Access Time (CL=100pF)		$t_{\sf ACC6}$	-	70	ns
Output Disable Time		t_{OH6}	10	50	ns
Enable High Pulse Width	READ	t _{EWHR}	70	-	ns
WRITE		t _{EWHW}	30	-	ns
Enable Low Pulse Width	READ	t _{EWLR}	30	-	ns
	WRITE	t _{EWLW}	30	<u> </u>	ns



2.3.3. Serial Interface Sequence

VDD=5.0±10%

Parameter	Symbol	Min.	Max.	Units
Serial Clock Cycle Time	t scyc	200	-	ns
Serial Clock High Pulse Width	t _{shw}	75	-	ns
Serial Clock Low Pulse Width	t _{SLW}	75	-	ns
Address Setup Time	t _{sas}	50	-	ns
Address Hold Time	t _{SAH}	100	-	ns
Data Setup Time	t _{SDS}	50	-	ns
Data Hold Time	t _{SDH}	50	-	ns
Chip Select Setup Time	t _{css}	100	-	ns
Chip Select Hold Time	t csH	100	-	ns



2.3.4. Display Control Timing Characteristics

Reset Input Timing VDD=5.0±10%

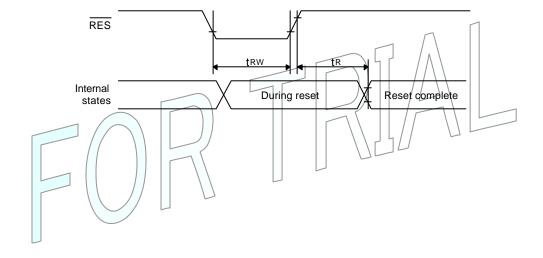
Parameter	Symbol	Min.	Тур.	Max.	Units
Reset time	t _R	-	-	0.5	ns
Reset "L" Pulse Width	\mathbf{t}_{RW}	0.5	-	-	μs

Output Timing VDD=5.0±10%

Parameter	Symbol	Min.	Тур.	Max.	Units
FR Delay Time	t _{DFR}	ı	10	40	ns

Note 1 :Valid only when the master mode is selected.

Note 2:All timing is based on 20% and 80% of Vss.

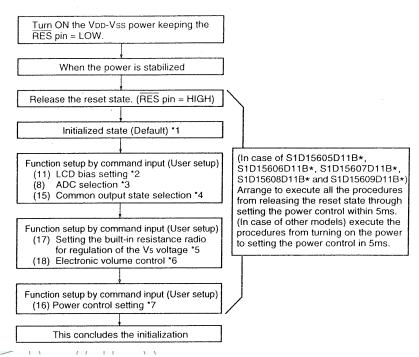


Instruction Setup: Reference (reference)

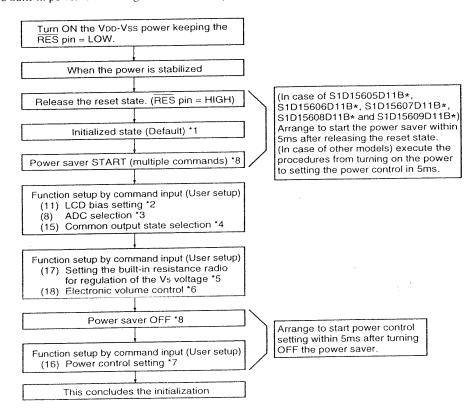
(1) Initialization

Note: With this IC, when the power is applied, LCD driving non-selective potentials V_2 and V_3 (SEG pin) and V_1 and V_4 (COM pin) are output through the LCD driving output pins SEG and COM. When electric charge is remaining in the smoothing capacitor connecting between the LCD driving voltage output pins ($V_1 \sim V_5$) and the V_{DD} pin, the picture on the display may become totally dark instantaneously when the power is turned on. To avoid occurrence of such a failure, we recommend the following flow when turning on the power.

① When the built-in power is being used immediately after turning on the power:



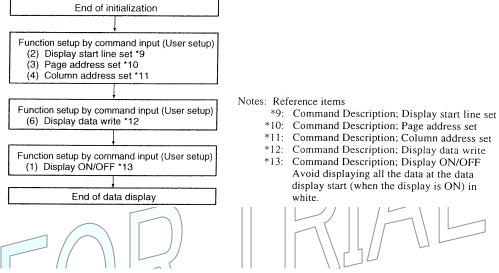
② When the built-in power is not being used immediately after turning on the power:



* The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

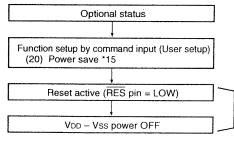
Notes: Refer to respective sections or paragraphs listed below.

- *1: 6. Description of functions; "Resetting circuit" (The contents of DDRAM can be variable even in the initial setting (Default) at the reset state.)
- *2: 7. Command description; "(11) LCD bias setting"
- *3: 7. Command description; "(8) ADC selection"
- *4: 7. Command description; "(15) Common output state selection"
- *5: 6. Description of functions; "Power circuit" & "(17) Command description; Setting the built-in resistance radio for regulation of the V5 voltage'
- *6: 6. Description of functions; "Power circuit" & "(18) Command description; Electronic volume control" *7: 6. Description of functions; "Power circuit" & "(16) Command description; Power control setting"
- 7. The power saver ON state can either be in sleep state or stand-by state. Command description; "Power saver START (multiple commands)"
- (2) Data Display



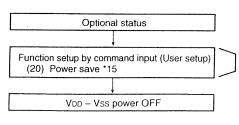
(3) Power OFF *14

In case of S1D15605D11B*, S1D15606D11B*, S1D15607D11B*, S1D15608D11B* and S1D15609D11B*,



Set the time (t) from reset active to turning off the VDD - Vss power (VDD - Vss = 1.8 V) longer than the time (t_H) when the potential of $V_5 \sim V_1$ becomes below the threshold voltage (approximately 1 V) of the LCD panel. For th, refer to the <Reference Data> of this event. When t_H is too long, insert a resistor between V_5 and V_{DD} to reduce it.

· In case of other models,



Set the time (tL) from power save to turning off the VDD - Vss power (VDD - Vss = 1.8 V) longer than the time (t_H) when the potential of V5 ~ V1 becomes below the threshold voltage (approximately 1V) of the LCD panel. th is determined depending on the voltage

regulator external resistors Ra and Rb and the time constant of V5 ~ V1 smoothing capacity C2.

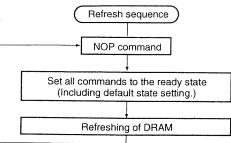
When an internal resistor is used, it is recommended to insert a resistor R between VDD and Vs to reduce th.

Notes: Reference items

- *14: The logic circuit of this IC's power supply VDD VSS controls the driver of the LCD power supply VDD - V5. So, if the power supply VDD - Vss is cut off when the LCD power supply VDD - V5 has still any residual voltage, the driver (COM. SEG) may output any uncontrolled voltage. When turning off the power, observe the following basic procedures:
 - After turning off the internal power supply, make sure that the potential V5 ~ V1 has become below the threshold voltage of the LCD panel, and then turn off this IC's power supply (VDD - VSS). 6. Description of Function, 6.7 Power Circuit
- *15: After inputting the power save command, be sure to reset the function using the RES terminal until the power supply VDD - Vss is turned off. 7. Command Description (20) Power Save
- After inputting the power save command, do not reset the function using the RES terminal until the power supply VDD Vss is turned off. 7. Command Description (20) Power Save

(4) Refresh

It is recommended that the operating modes and display contents be refreshed periodically to prevent the effect of unexpected noise.





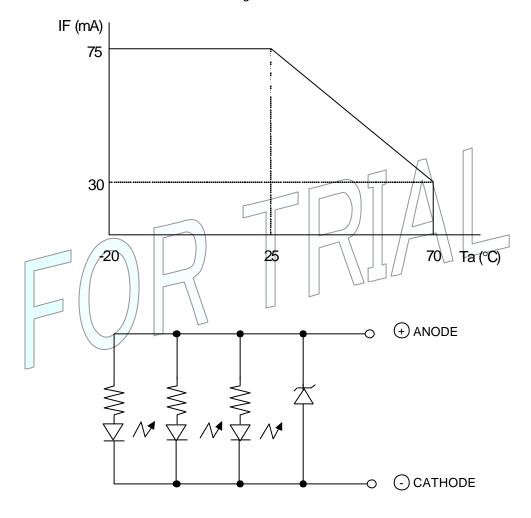
2.4. Lighting Specifications

2.4.1. Absolute Maximum Ratings

Ta=25°C (1Unit)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	l F	Note 1	-	ı	75	mA
Reverse Voltage	VR	-	-	1	8	V
LED Power Dissipation	PD	-	-	-	0.375	W

Note 1 : Refer to the foward current derating curve.



2.4.2. Operating Characteristics

Ta=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Voltage	VF	I=40mA	ı	5.0	ı	V
Luminance of	L	l==40mA	65	100	-	cd/m ²
Backlight Surface						

3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta= -20°C	-	-	9.1	V
LCD Driving Voltage	VDD-V5	Ta=25°C	7.8	8.5	9.1	V
Note 1		Ta=70°C	7.4	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/65 Duty, 1/7 Bias, VoD=8.5V (Note 4), θ = 0°, ϕ = - °

			, · · · · · , · · · · , · · · · ·				
Pa	rameter	Symbol	Conditions Min. Typ.			Max.	Units
Contrast Ra	atio Note 1	CR	θ= 0°, φ= - °	-	8	-	
Viewing An	gle		Shown in 3:3				
Response	Rise Note 2	Том	- 1	\	/\160	240	ms
Time	Decay Note 3	Toff) -	190	290	ms

Note 1 :Contrast ratio is definded as follows. (CR = Lon / Loff)

Lon: Luminance of the ON segments

Loff: Luminance of the OFF segments

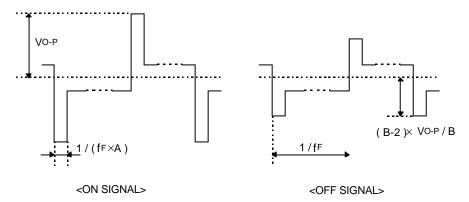
Mesuring Spot=3mmo

- Note 2 The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.
- Note 3 The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

Note 4: Definition of Driving Voltage Vod

Vod=Vcc-Vadj-Vbe

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage Vod is definded as the voltage Vod when the contrast ratio (CR=Lon / Loff) is at its maximum.



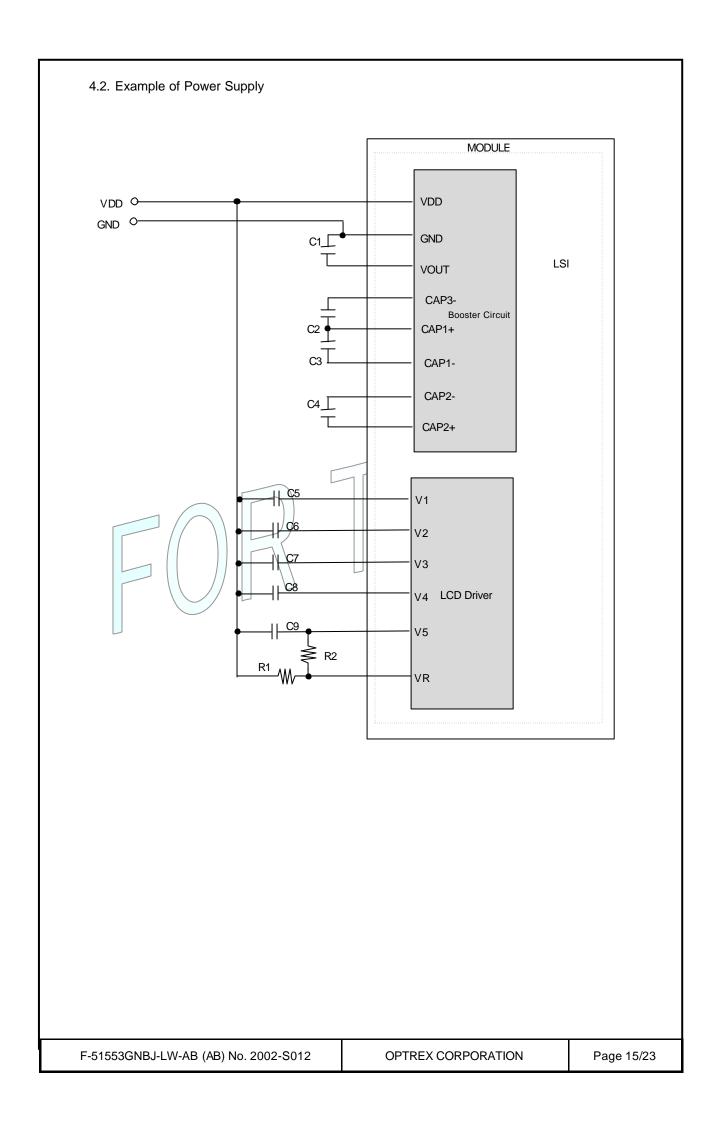
3.3. Definition of Viewing Angle and Optimum Viewing Area *Point • shows the point where contrast ratio is measured. : θ = 0°, ϕ = -° *Driving condition: 1/65 Duty, 1/7 Bias, VoD=8.5V, fF=84.6Hz 90° 45° 135° 90° 180° $(\phi = 0^{\circ})$ 180° 225° 315° 270° 270° *Area shows typ. CR≥3 (Mesuring Spot=3mmo) 3.4. System Block Diagram Temperature Chamber Rotation Table (θ, ϕ) Photometer #1980A WB LCD Optical Fiber Control Unit & Computer Waveform Generator Halogen bulb Page 13/23 F-51553GNBJ-LW-AB (AB) No. 2002-S012 **OPTREX CORPORATION**

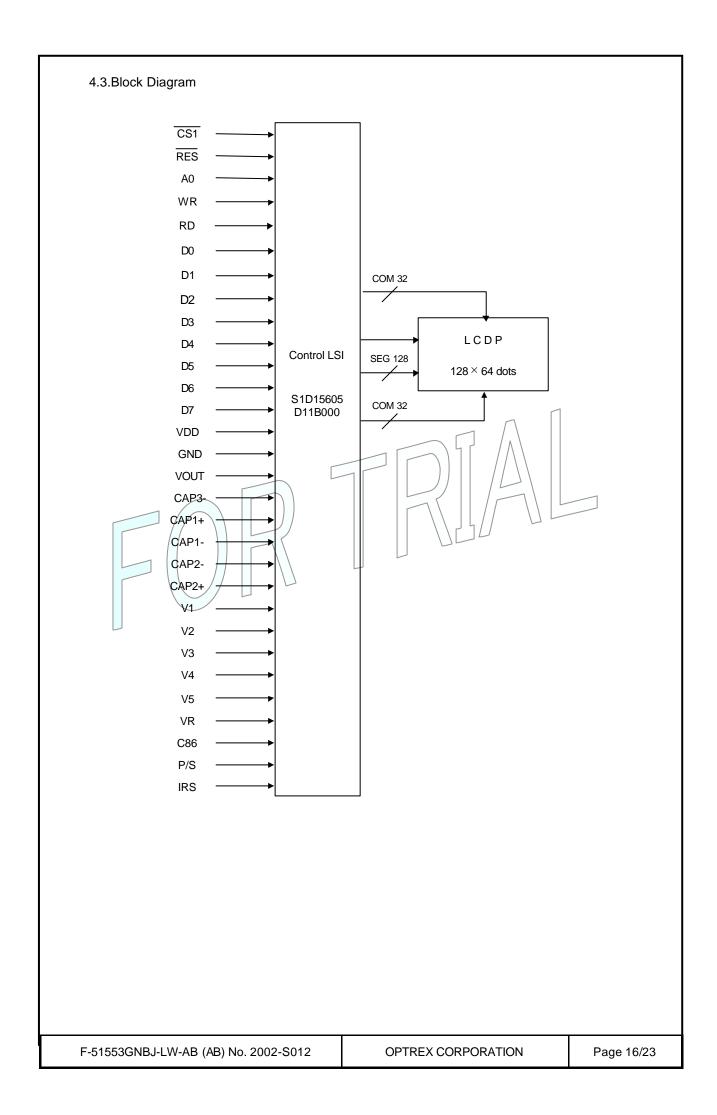
4.I/O Terminal

4.1. Pin Assignment

CN1

CN1 No.	Symbol	Function			
1	CS1	Chip Select Signal L : Active			
2	RES	Reset Signal L : Reset			
3	A0	H : D0~D7 are Display Data L : D0~D7 are Instructions			
4	WR	Write Signal L : Active			
5	RD	Read Signal L : Active			
6	D0	Data Bus Line			
7	D1	Data Bus Line			
8	D2	Data Bus Line			
9	D3	Data Bus Line			
10	D4	Data Bus Line			
11	D5	Data Bus Line			
12	D6	Data Bus Line			
13	D7	Data Bus Line			
14	VDD	Power Supply for Logic			
15	GND/	Power Supply/(0V, GND)			
16	Vour	DC/DC Voltage Converter Output			
17	САР3-	DC/DC Voltage Converter Negative Connection			
18	CAP1+	DC/DC Voltage Converter Positive Connection			
19	CAP1-	DC/DC Voltage Converter Negative Connection			
20	CAP2-	DC/DC Voltage Converter Negative Connection			
21	CAP2+	DC/DC Voltage Converter Positive Connection			
22	V ₁	Power Supply for LCD Drive V ₁ = 1/7,V ₅			
23	V ₂	Power Supply for LCD Drive $V_2 = 2/7, V_5$			
24	V3	Power Supply for LCD Drive V ₃ = 5/7,V ₅			
25	V4	Power Supply for LCD Drive V ₄ = 6/7,V ₅			
26	V5	Power Supply for LCD Drive V₅,Vou⊤			
27	VR	Voltage Adjustment Pin			
28	C86	Interface Mode Select Signal H: 68 series L: 80 series			
29	P/S	Parallel / Serial Data Select Signal H: Parallel L: Serial			
30	IRS	This terminal selects the resistors for the V5 voltage level adjustment.			
		IRS="H" :Use the internal resistors			
		IRS="H" :Do not use the internal resistors. The V5 voltage			
		level is requlated by an external resistive voltage divider attached			
		to the VR terminal.			
	<u> </u>				





5.Test

No change on display and in operation under the following test condition.

Conditions: Unless otherwise specified, tests will be conducted under the following condition.

Temperature: 20±5°C Humidity: 65±5%RH

tests will be not conducted under functioning state.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	70°C±2°C, 96hrs (operation state)	
2	Low Temperature Operating	-20°C±2°C, 96hrs (operation state)	1
3	High Temperature Storage	85°C±2°C, 96hrs	2
4	Low Temperature Storage	-30°C±2°C, 96hrs	1,2
5	Damp Proof Test	40°C±2°C,90~95%RH, 96hrs	1,2
7	Temperature Cycle Test Shock Test	The function test shall be conducted after 1 hours storage at the normal temperature and humidity after removed from the test chamber. To be measured after dropping from 60cm high on the concrete surface in packing state. Dropping method comer dropping A corner: once Edge dropping B,C,D edge: once Face dropping E,F,G face: once	1

Note 1: No dew condensation to be observed.

Note 2 :The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after removed from the test chamber.

Note 3: Vibration test will be conducted to the product itself without putting it in a container.

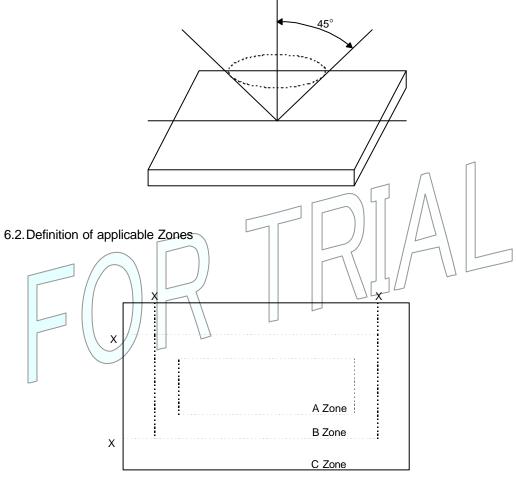
6. Appearance Standards

6.1. Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



X : Maximum Seal Line

A Zone : Active display area

B Zone : Out of active display area ~ Maximum seal line

C Zone: Rest parts

A Zone + B Zone = Validity viewing area

6.3. Standards

No.	Parameter			Criteria			
1	1 Black and		(1) Round Shape				
	White Spots,		Zone	Acc	ceptable Num	ber	
	Foreign Substances		Dimension (mm)	Α	В	С	
			D ≤0.1	*	*	*	
			0.1 < D ≤ 0 .2	3	5	*	
			0.2 < D ≤ 0 .25	2	3	*	
			0.25< D ≤0.3	0	1	*	
			0.3 < D	0	0	*	
			D = (Long + Short) / 2 *: Disregard				
		(2) Line Shape				
			Zone	Acc	ceptable Num	ber	
			X (mm) Y (mm)	Α	В	С	
			- 0.03 ≥ W		*	*	
			2.0 ≥ L 0.05 ≥ W	3	//\\3	*	
			1.0 ≥ L 0.1 ≥ W	//3 /	3	*	
			- 0.1 < W In the same way (1)				
			X: Length Y: Width *	: Disregard			
		To	otal defects shall not excee	ed 5.			
2	Air Bubbles			Г			
	(between glass		Zone	Acc	ceptable Num	ber	
	& polarizer)		Dimension (mm)	А	В	С	
			D ≤ 0 .3	*	*	*	
			0.3 < D ≤ 0 .4	3	*	*	
			0.4 < D ≤0.6	2	3	*	
			0.6 < D	0	0	*	
			* : Disregard				
		T	otal defects shall not excee	ed 3.			

No.	Parameter	Criteria			
3	The Shape of Dot	(1) Dot Shape (with Dent)			
		0.15 <u>≥</u> ; :			
		As per the sketch of left hand.			
		(2) Dot Shape (with Projection)			
		Should not be connected to next det			
		Should not be connected to next dot.			
		(3) Pin Hole			
		<u> </u>			
		(X+Y)/2 ≤ 0.2mm			
		(Less/than 0.1mm is no counted.)			
		(4) Deformation			
		(X.X) (2 < 0.2			
		$(X+Y) / 2 \le 0.2 mm$			
		<mark>∢ x →</mark>			
		Total acceptable number : 1/dot, 5/cell			
		(Defect number of (4): 1pc.)			
4	Polarizer Scratches	Not to be conspicuous defects.			
5	Polarizer Dirts	If the stains are removed easily from LCDP surface, the module is no			
	Complete	Discharge line should foreign substances or six bubbles between			
6	Complex Foreign	Black spots, line shaped foreign substances or air bubbles between			
7	Substance Defects	glass & polarizer should be 5pcs maximum in total.			
7	Distance between	D ≤ 0.2 : 20mm or more			
	Different Foreign Substance Defects	0.2 < D : 40mm or more			
	Substance Defects				

7.Code System of Production Lot The production lot of module is specified some of the following. - Factory Number (Numeral) Factory Code (Alphabet) Production Week (1~5) Production Month (1~9, X, Y, Z) Production Year (Lower 2 digits) Factory Number (Numeral) Production Day of the Week (Sun : A Mon : B~) **Factory Code** Production Week (1~5) Production Month (1~9, X, Y, Z) Production Year (Lower 2 digits) 8. Type Number The type number of module is specified as follows. F-51553GNBJ-LW-AB

9. Applying Precautions

Please contact us when questions and/or new problems not specified in this Specifications arise.

10.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
 - 1. The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
 - 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
 - 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
 - 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
 - 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
 - 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
 - 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
 - 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
 - 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
- 8) For models which use touch panels:
 - 1. Do not stack up modules since they can be damaged by components on neighboring modules.
 - 2. Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG, TAB, or COF:
 - 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
 - 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

- 10) Models which use flexible cable, heat seal, or TAB:
 - 1. In order to maintain reliability, do not touch or hold by the connector area.
 - 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11) have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials.
 - Please check and evaluate these materials carefully before use.
- 12) In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film..
 - Please check and evaluate those acrylic materials carefully before use.

11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- We cannot accept responsibility for any defect, which may arise due to the application
 of static electricity after the product has passed your company's acceptance inspection
 procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary According to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe, Display LC delivery which ever comes later.